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Application No. 11-330270, filed November 19, 1999, and Japanese Patent Application  
No. 11-335641, filed November 26, 1999. --

**IN THE CLAIMS:**

✓ Please cancel claims 1-10 without prejudice or disclaimer and substitute new  
✓ ✓ ✓ claims 11-28 therefor as follows: ✓ ✓

**WHAT IS CLAIMED IS:**

11. (New) A ceramic heater comprising:  
a ceramic substrate; and heat generation means disposed within said  
ceramic substrate, at least part of said heat generation means being disposed on an  
offset level different from that of others of said heat generation means in the direction of  
thickness of said ceramic substrate.
12. (New) The ceramic heater according to claim 11, wherein said heat generation  
means are disposed such that a level of adjoining ones to others is offset in the  
direction of thickness of said ceramic substrate.
13. (New) The ceramic heater according to claim 11, wherein said heat generation  
means is flat in cross-section.
14. (New) The ceramic heater according to claim 13, wherein an amount of offset  
displacement in level of mutually adjacent heat generation means is in a range of 1 to  
100  $\mu\text{m}$ .

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